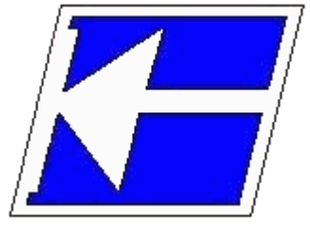
Instituto Federal de Educação, Ciência e Tecnologia de Santa Catarina
Departamento Acadêmico de Eletrônica

Eletrônica de Potência



Semicondutores de Potência
BJT, MOSFET e IGBT

Prof. Clovis Antonio Petry.

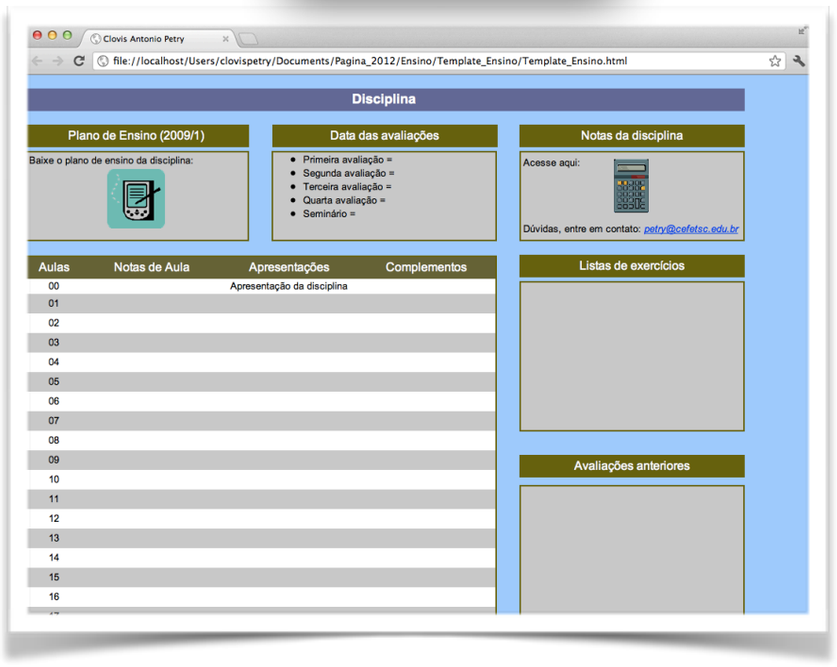
Florianópolis, agosto de 2018.

Biografia para Esta Aula

Capítulos 3:

- Transistores de potência.

www.ProfessorPetry.com.br



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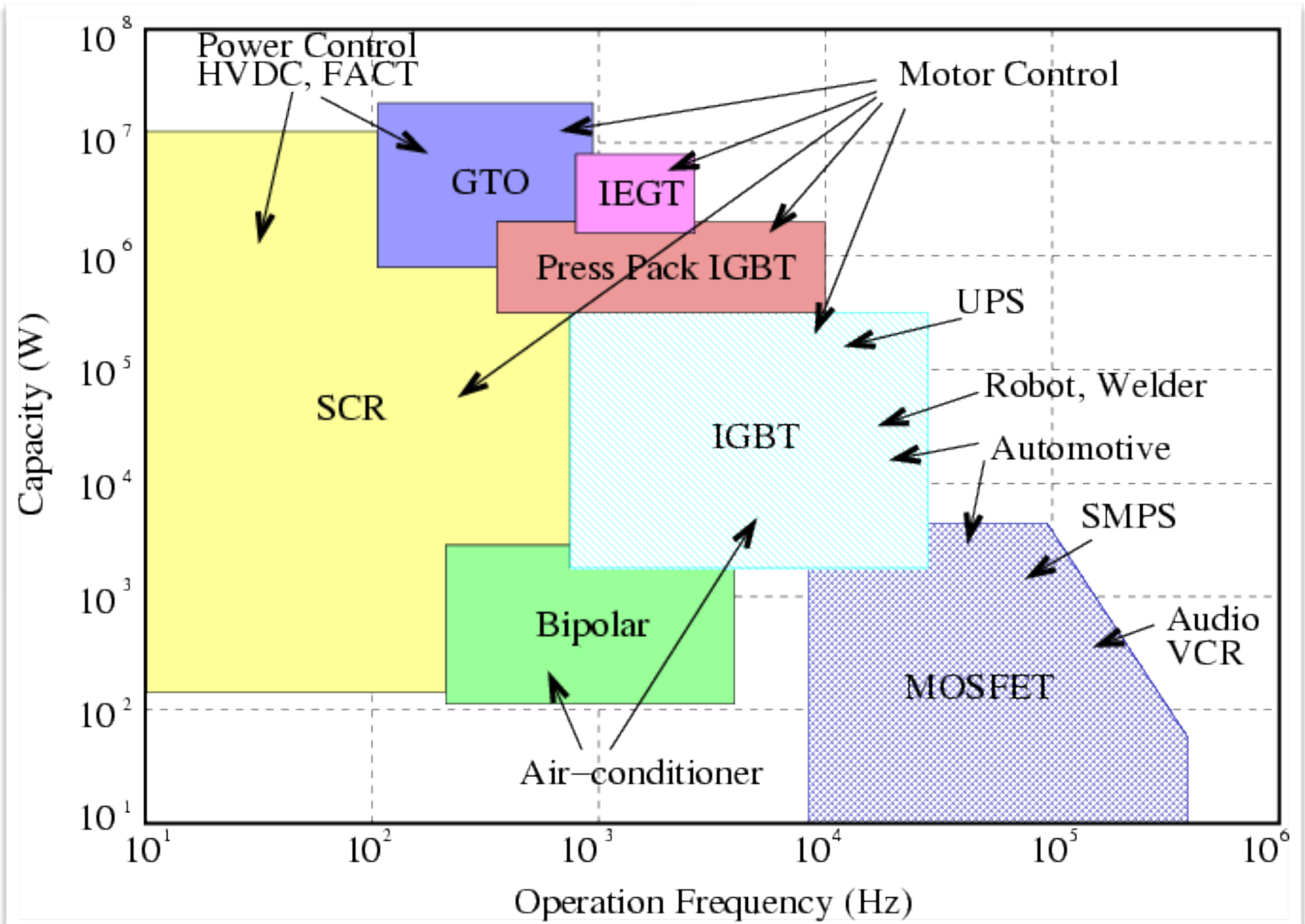
Nesta Aula

Semicondutores de potência:

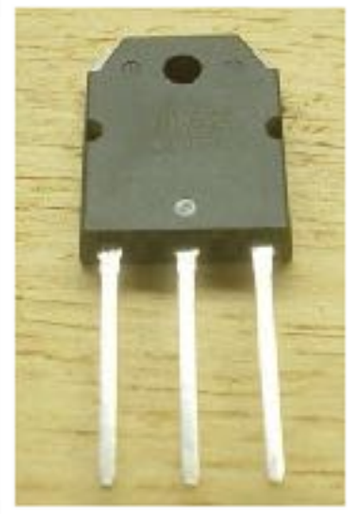
- Semicondutores para eletrônica de potência;
- Revisão de BJT;
- BJT x FET;
- FETs;
- MOSFETs;
- IGBTs.

Semicondutores de Potência

Semicondutores aplicados à eletrônica de potência:

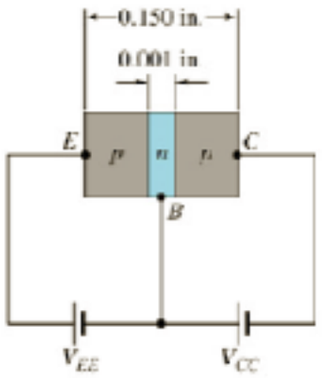


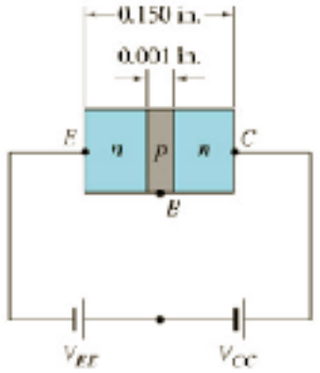
Semicondutores de Potência

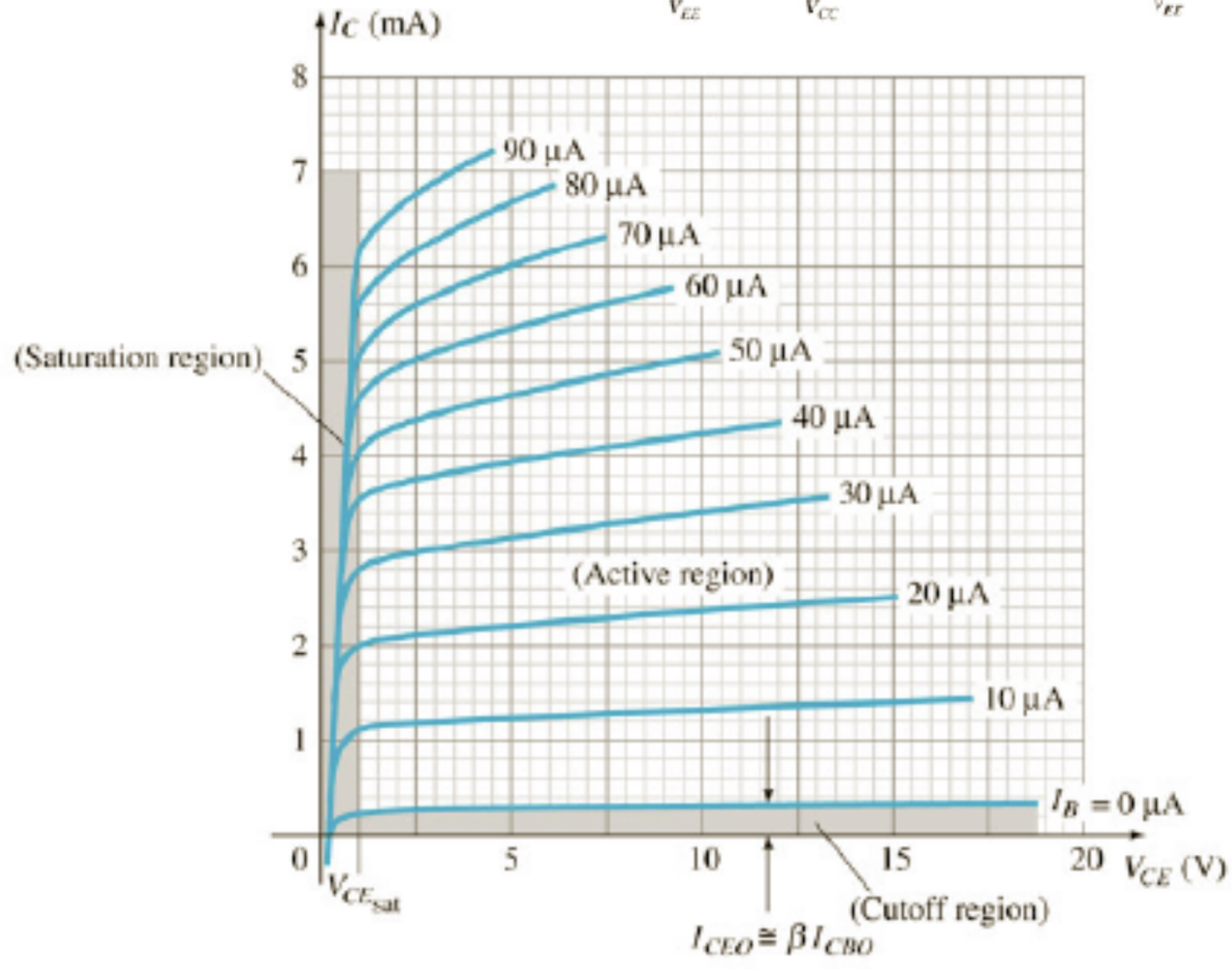


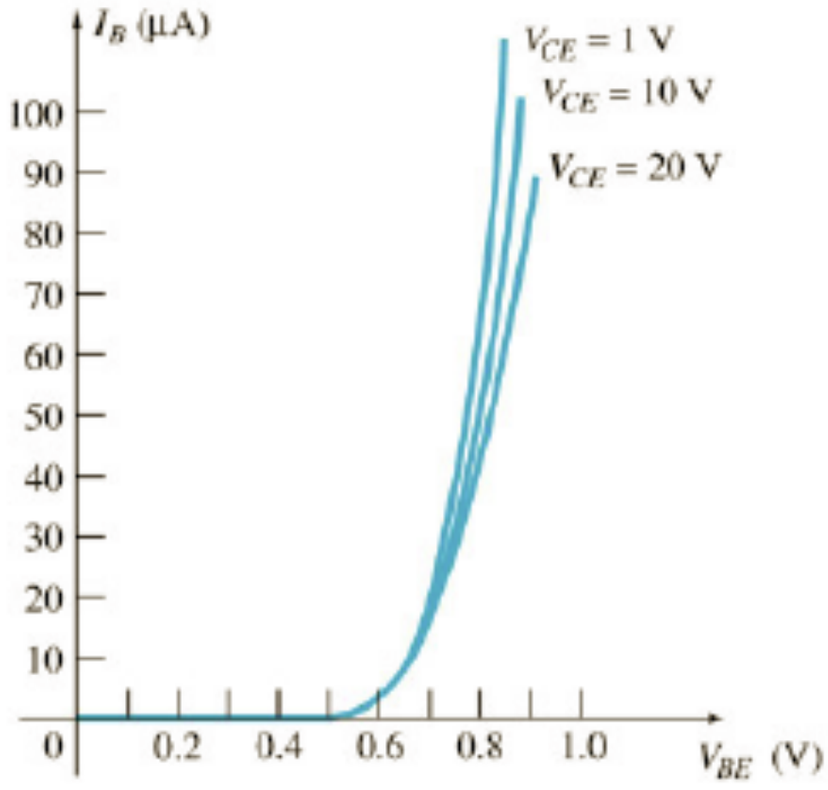
Revisão - BJT

BJT - Transistor bipolar de junção



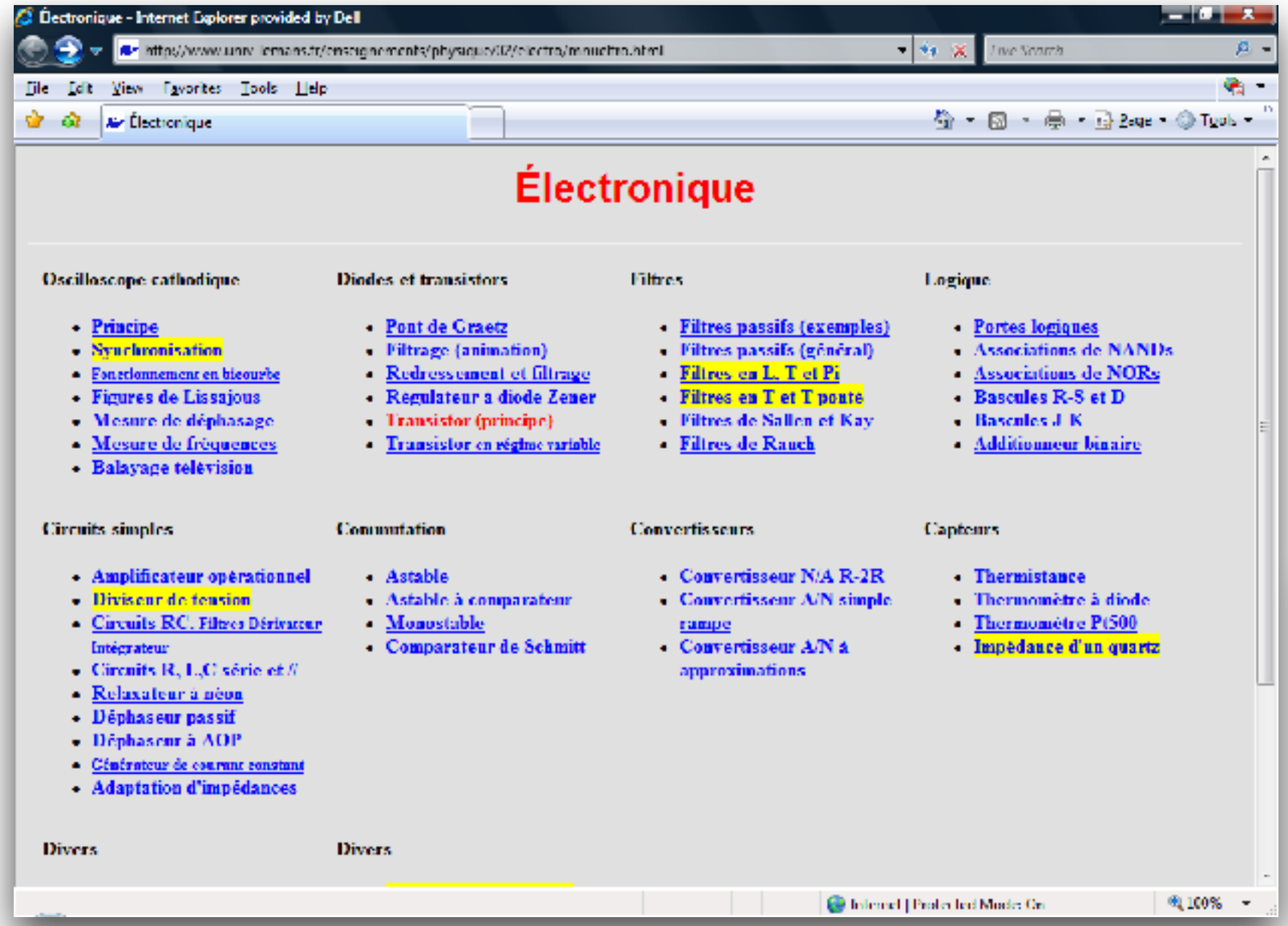


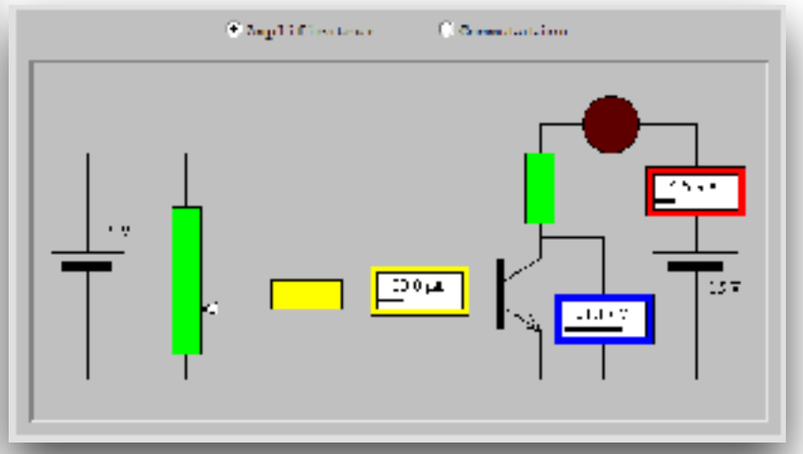




Revisão - BJT

Tarefa

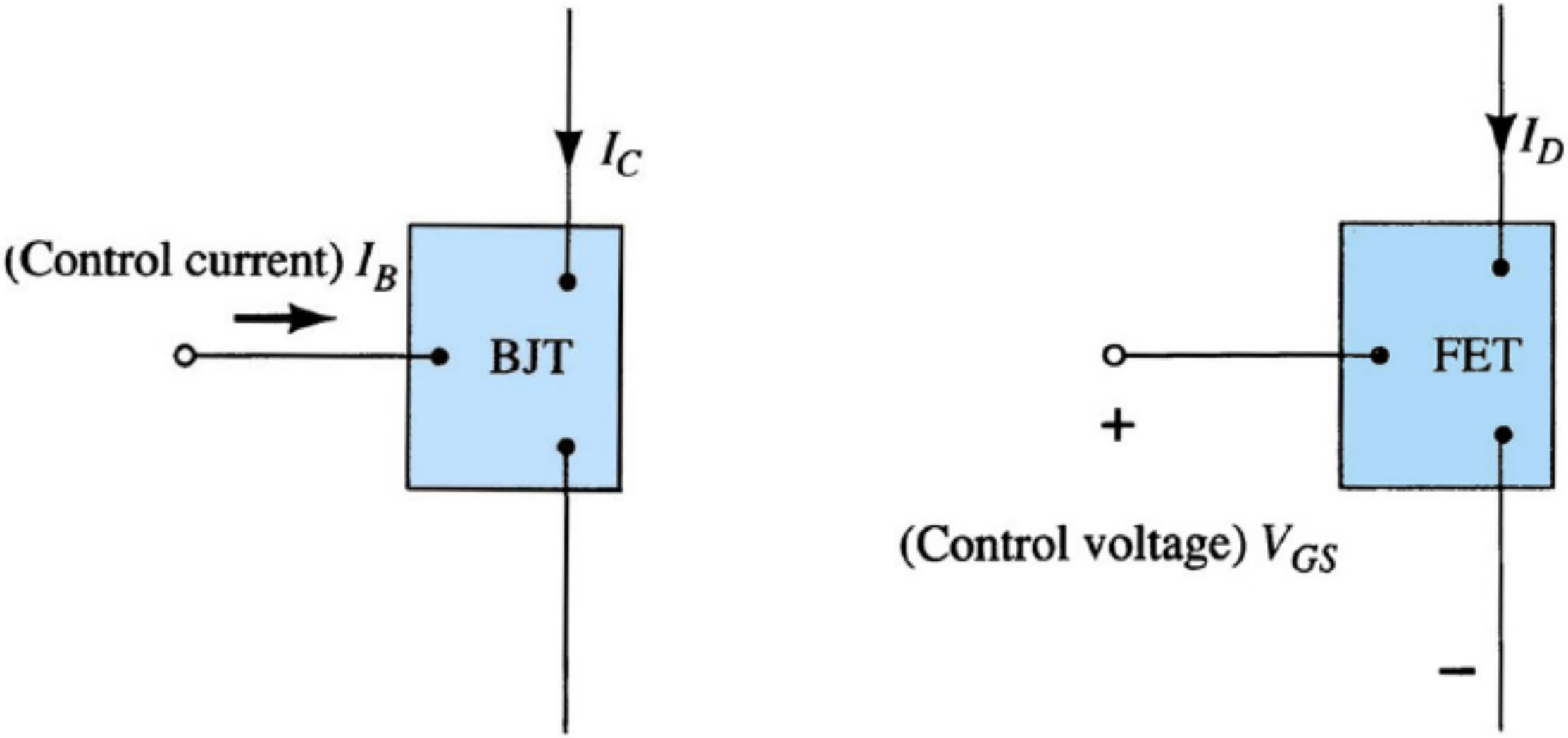




http://www.univ-lemans.fr/enseignements/physique/02/electro/mnueltro.html

BJT x FET

FET - Transistor de efeito de campo



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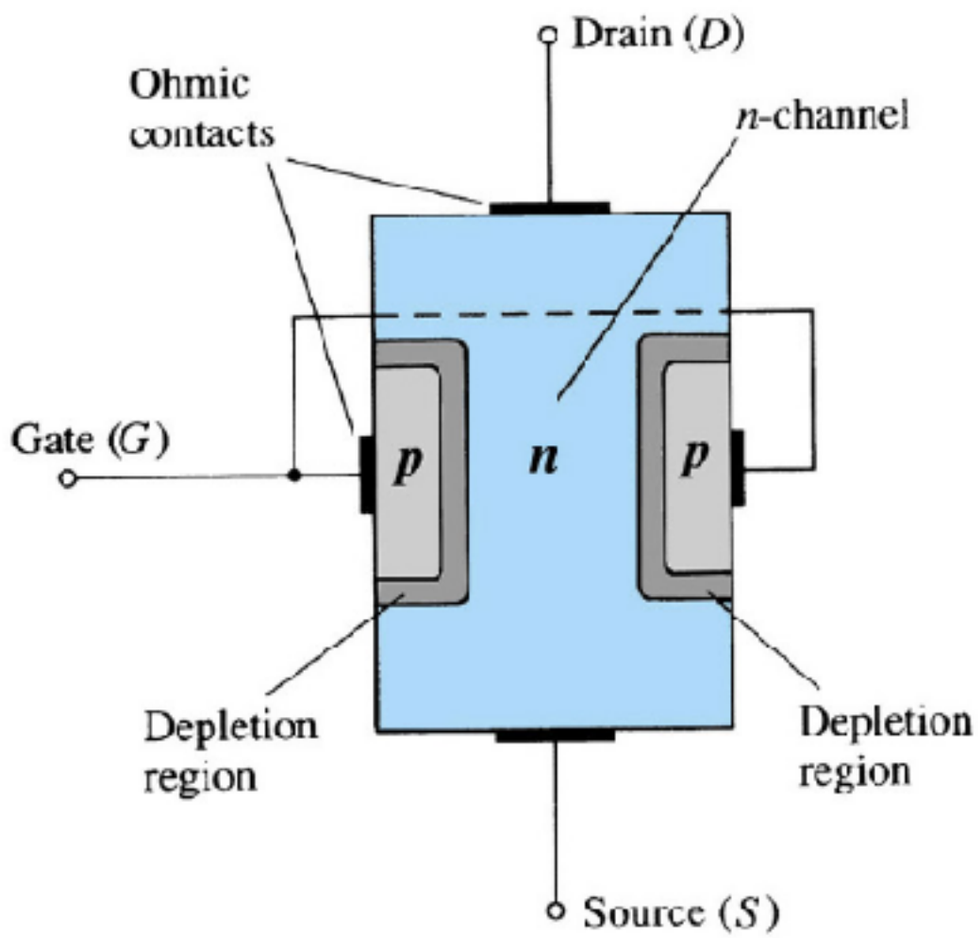
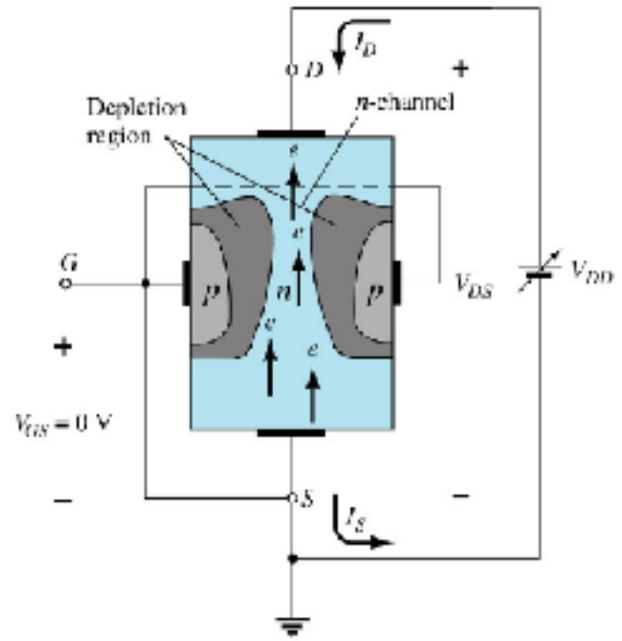
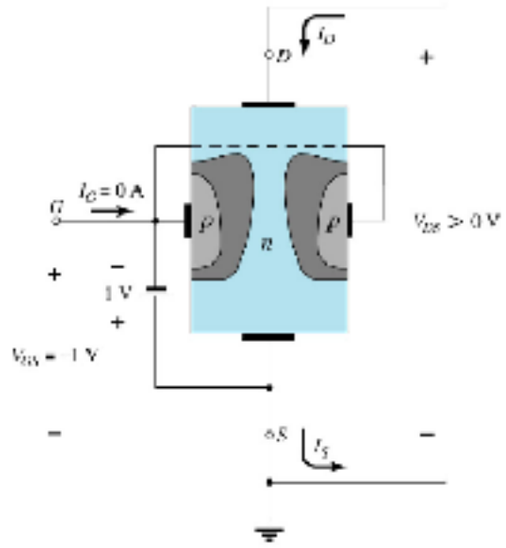
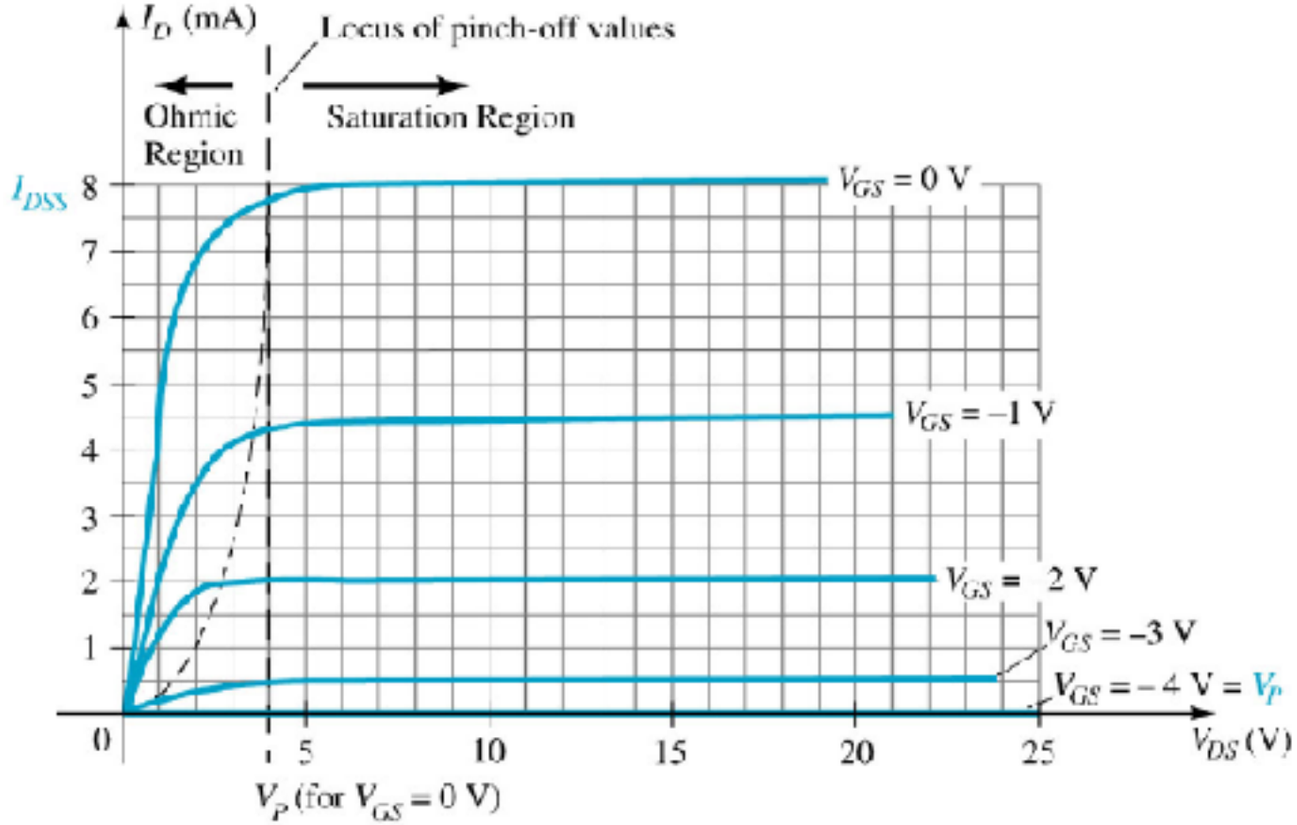
FET



JFET: Operação básica







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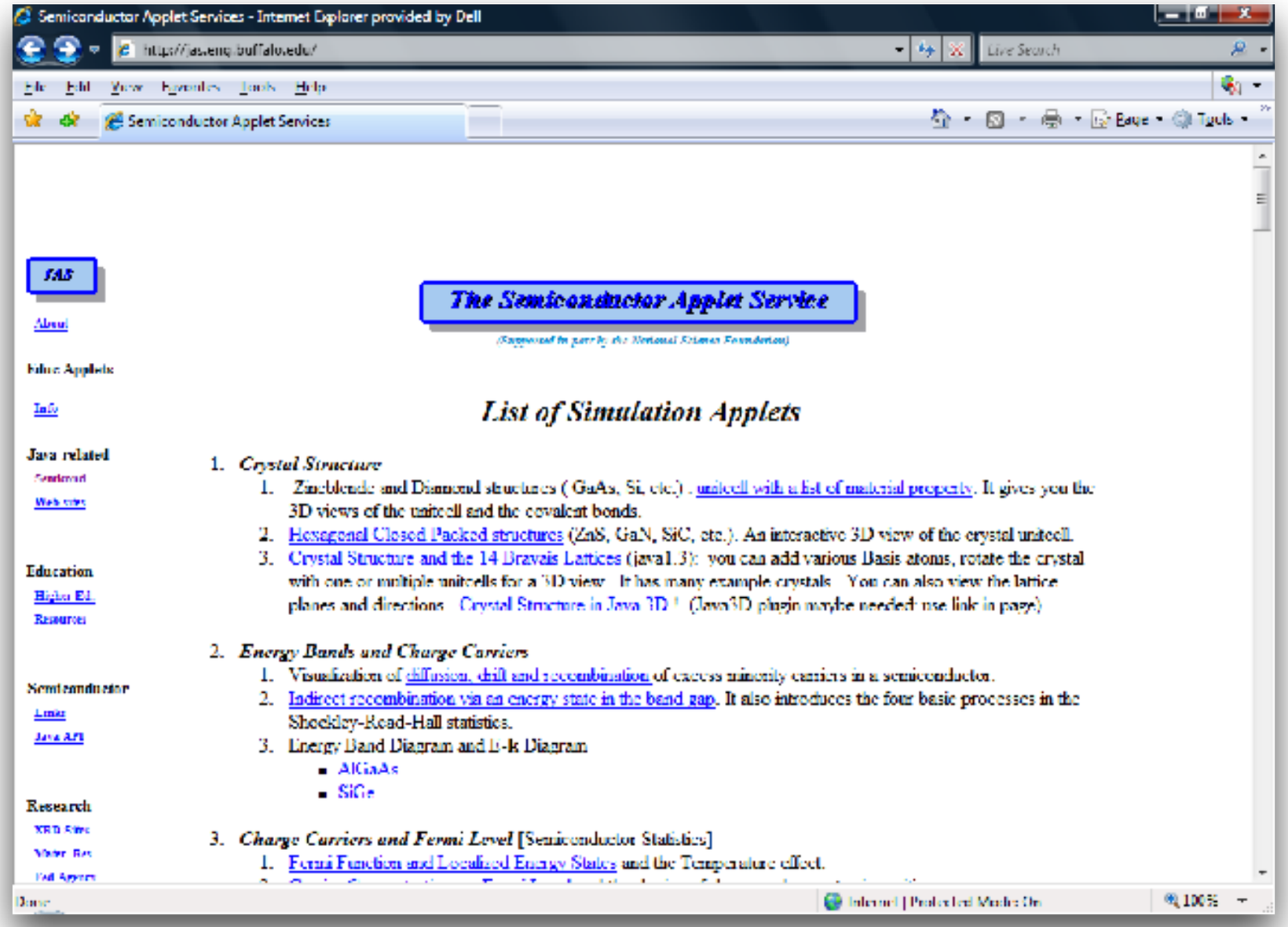
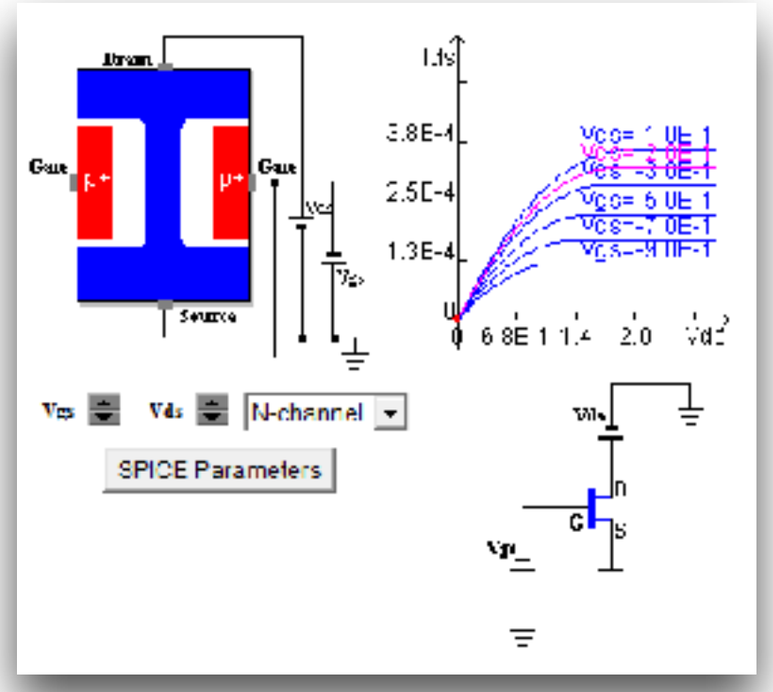
Tarefa



http://jas.eng.buffalo.edu/



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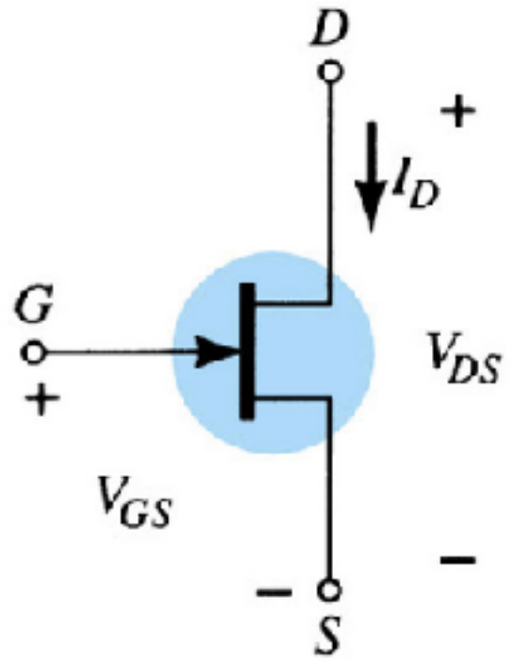
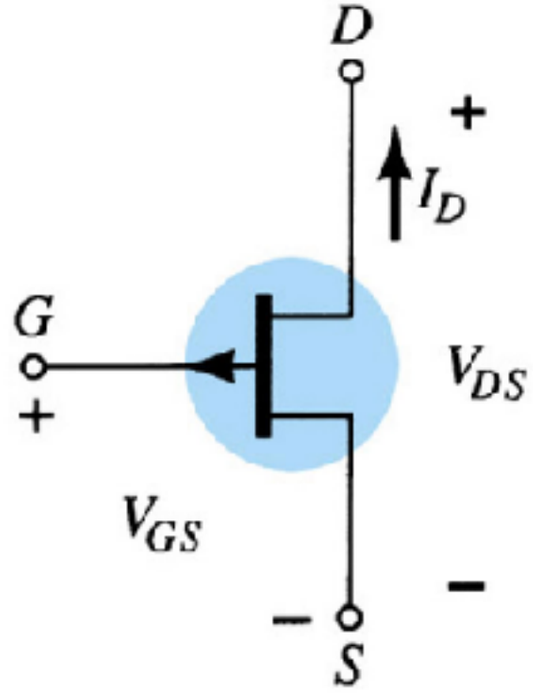
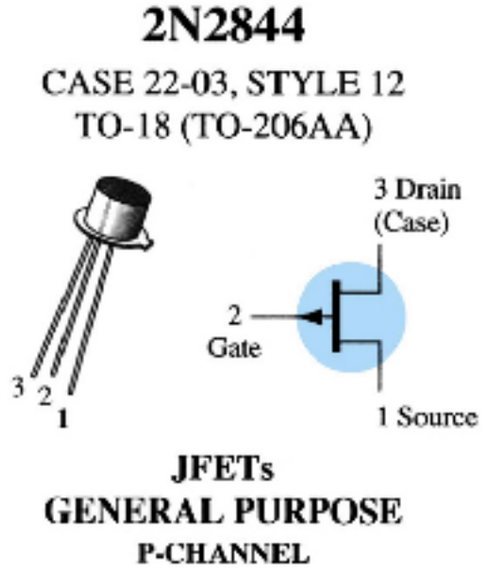
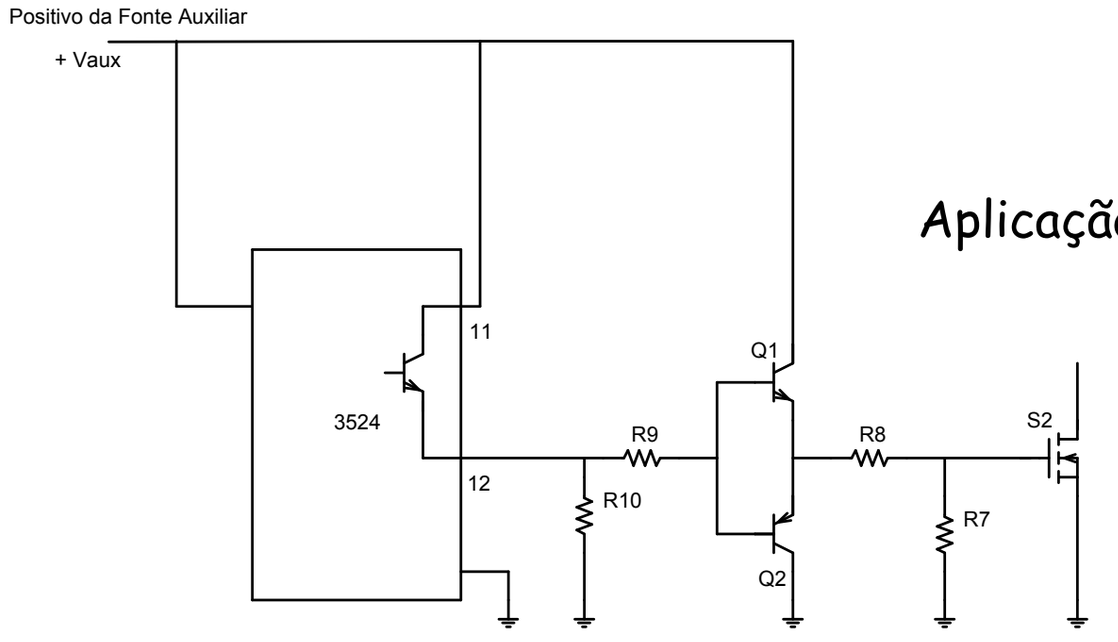




JFET canal n e canal p

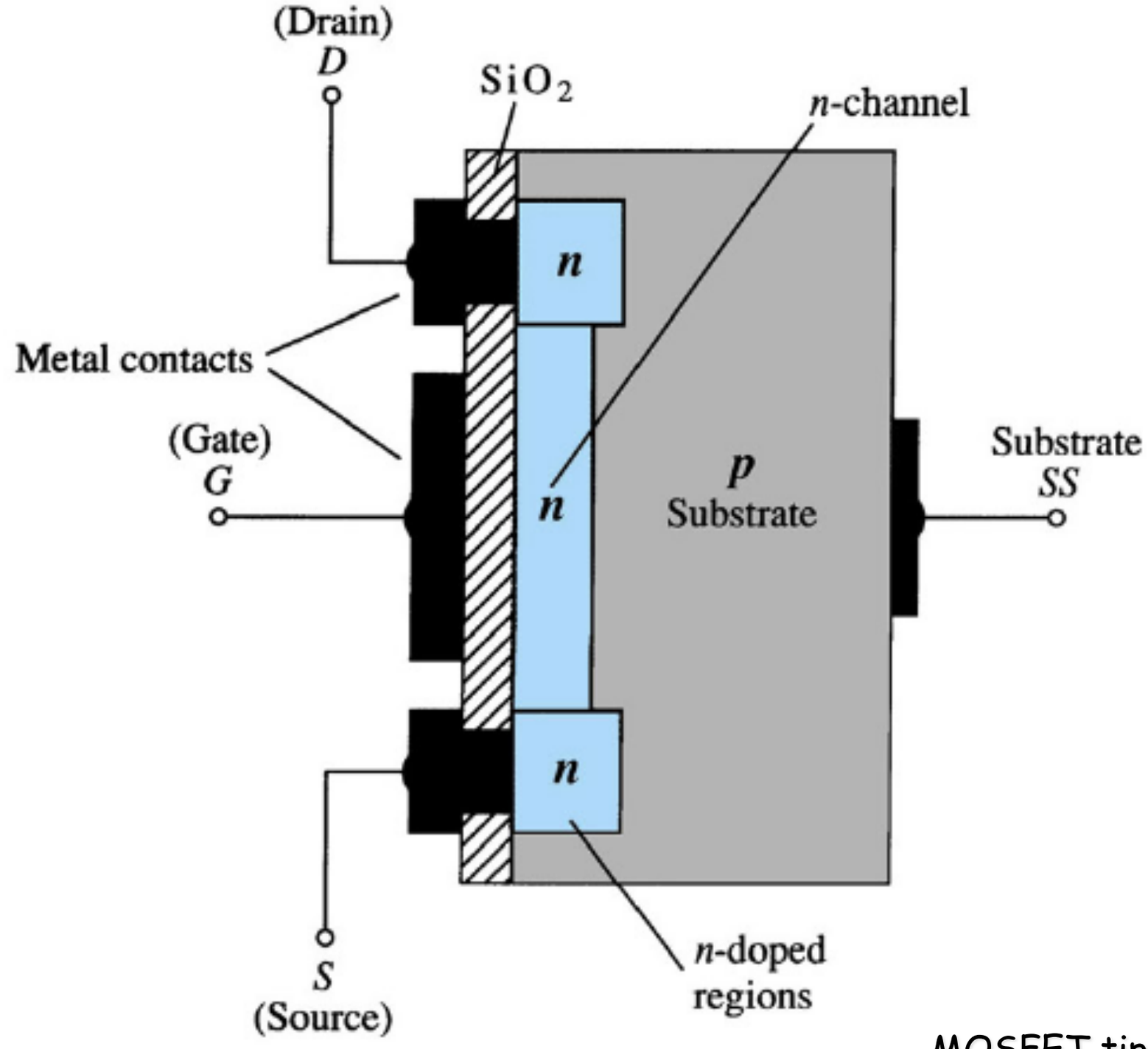




Aplicação do JFET

MOSFET

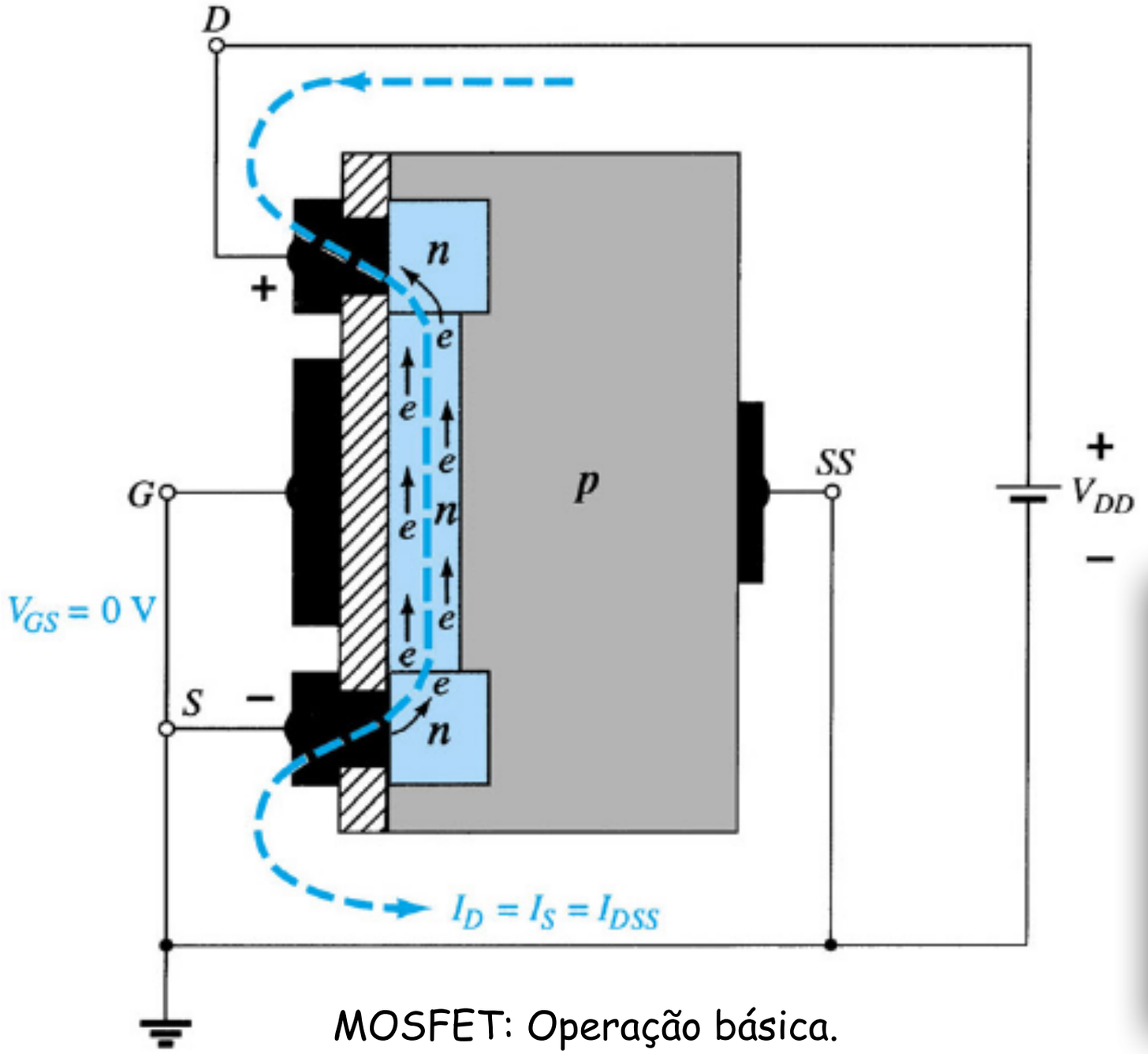
MOSFET – Metal Oxide Semiconductor Field Effect Transistor



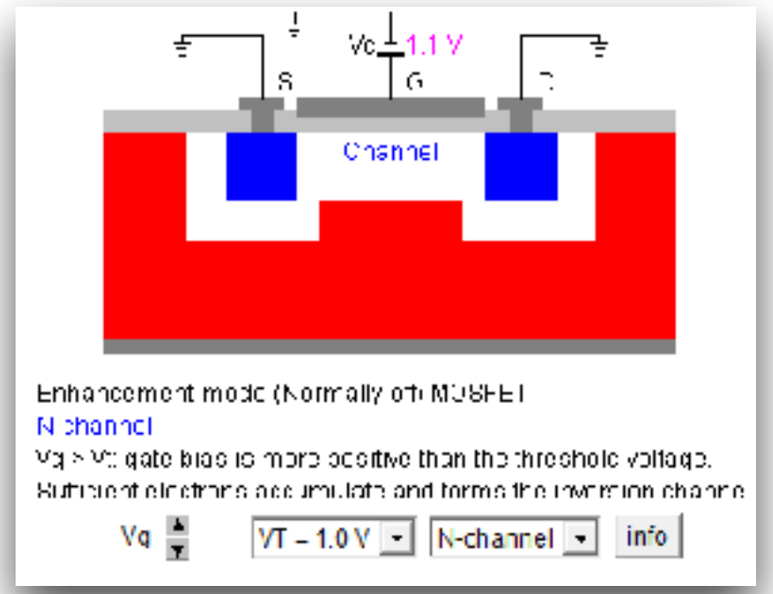
MOSFET tipo Depleção

MOSFET

MOSFET tipo Depleção



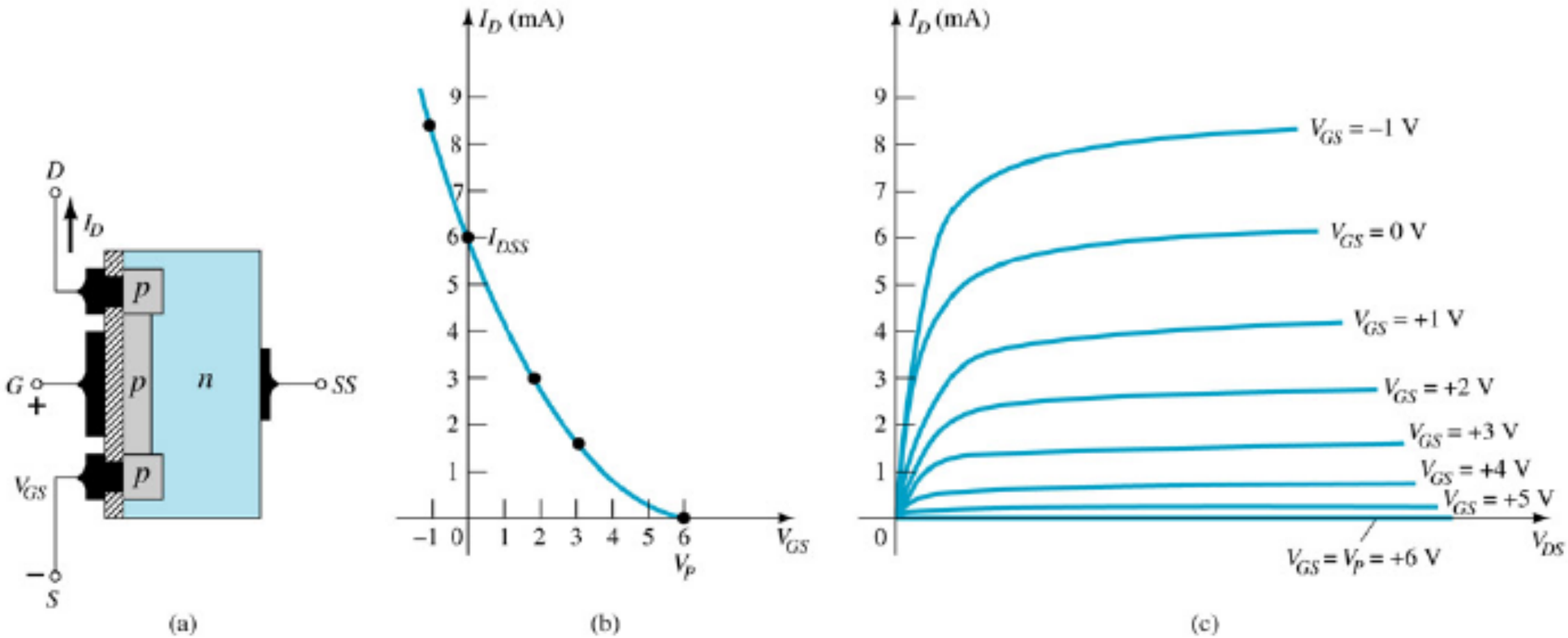
MOSFET: Operação básica.



http://jas.eng.buffalo.edu/

MOSFET

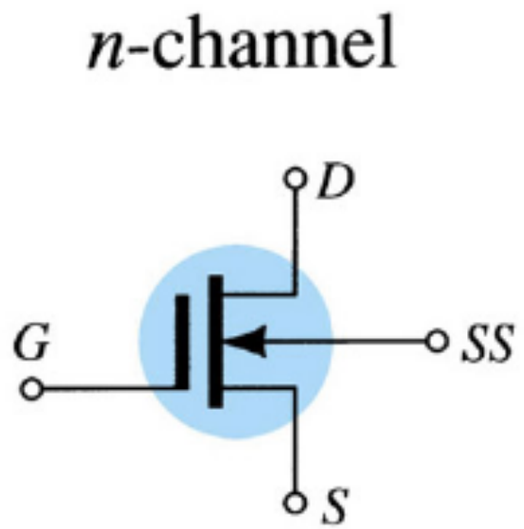
MOSFET tipo Depleção

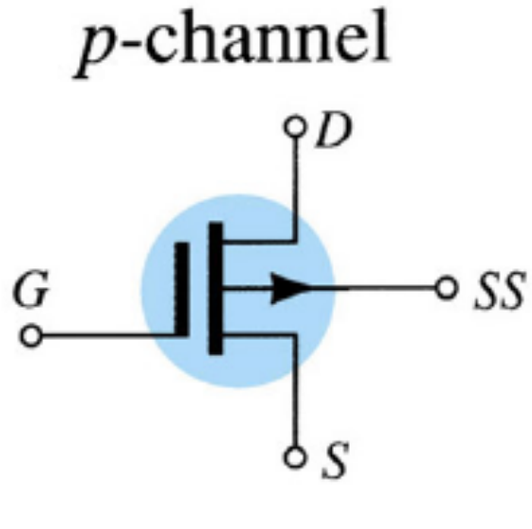


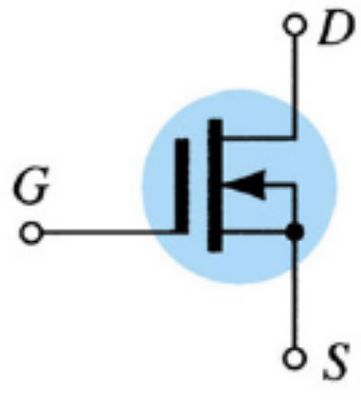
MOSFET: Operação básica.

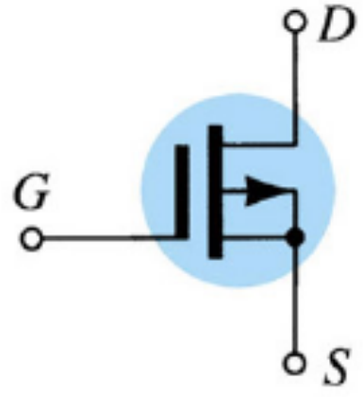
MOSFET

MOSFET tipo Depleção



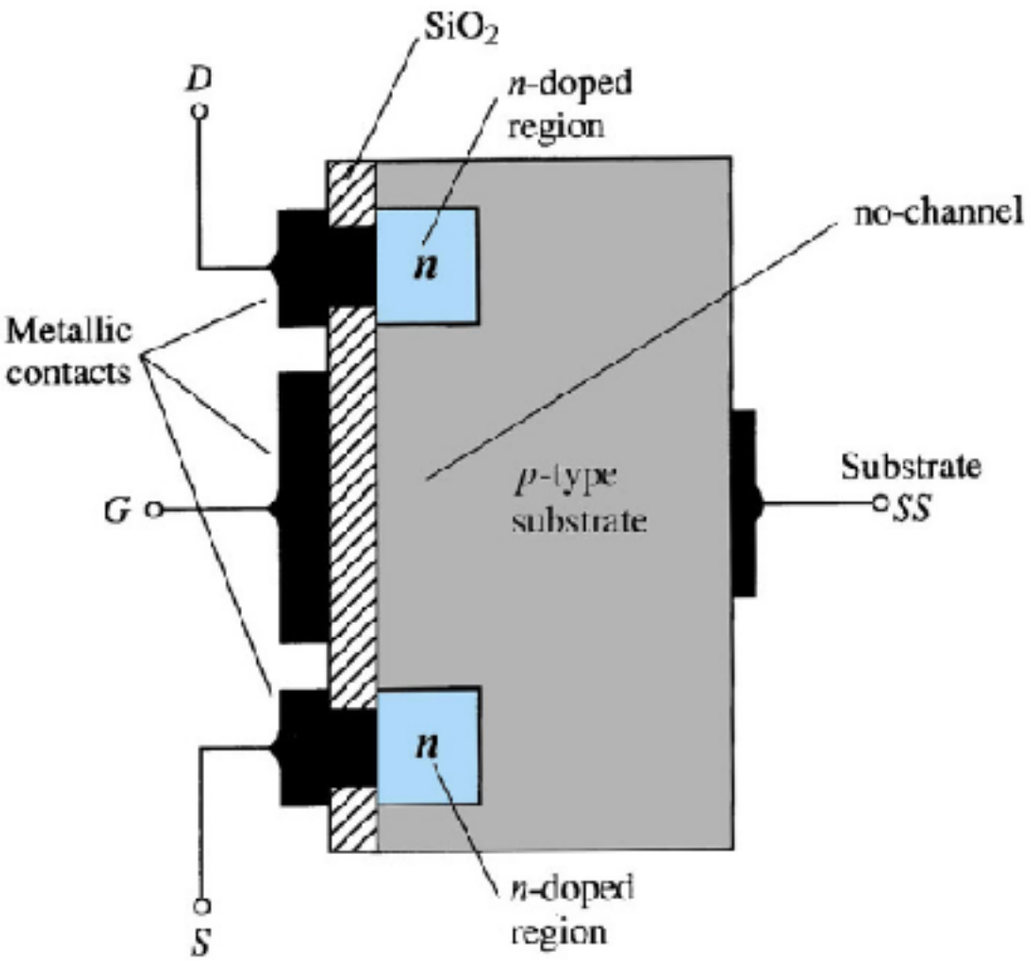


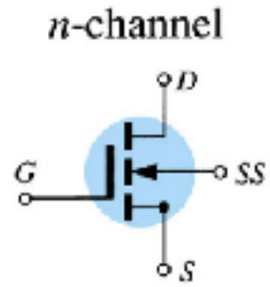


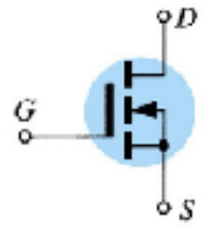


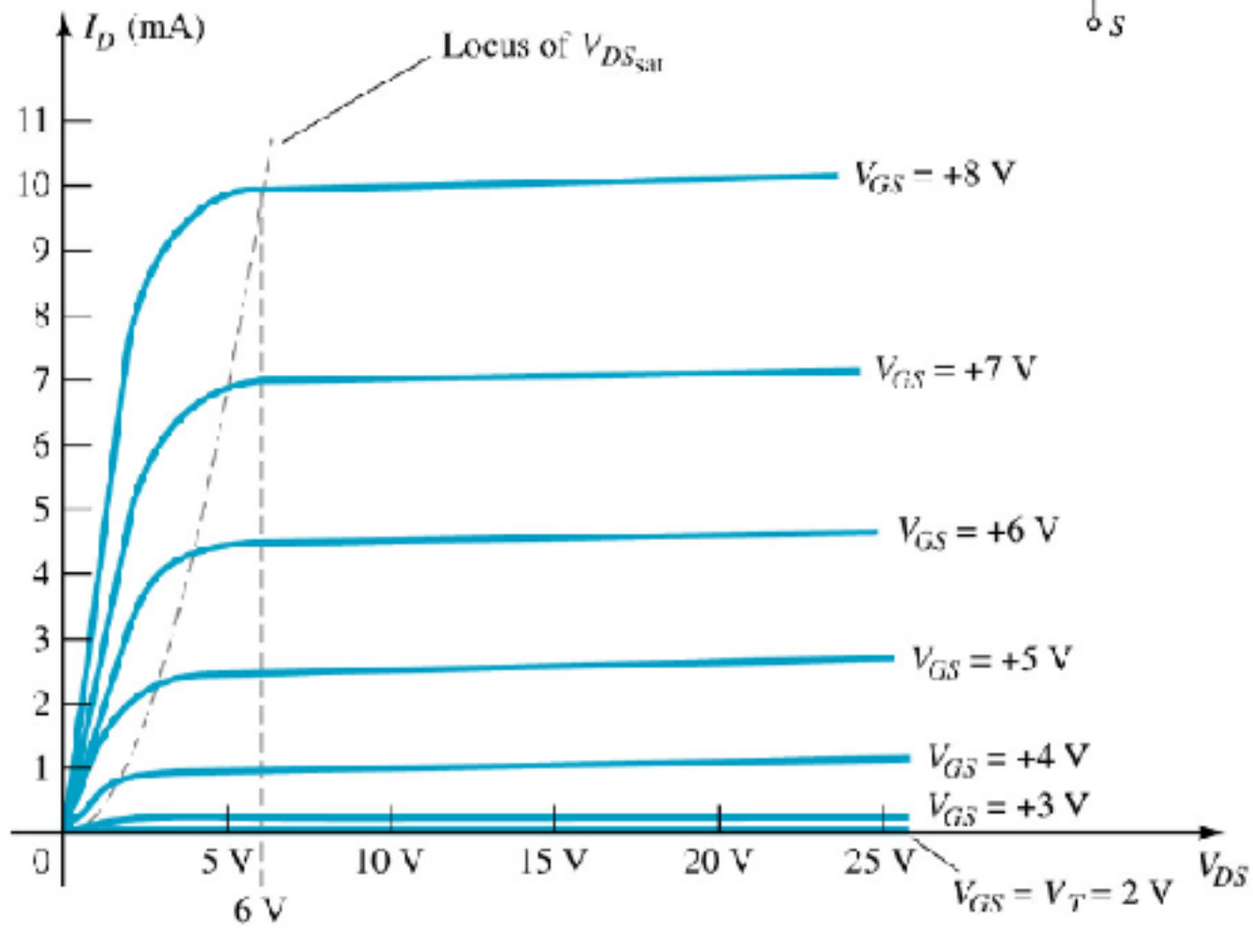
MOSFET

MOSFET tipo Intensificação





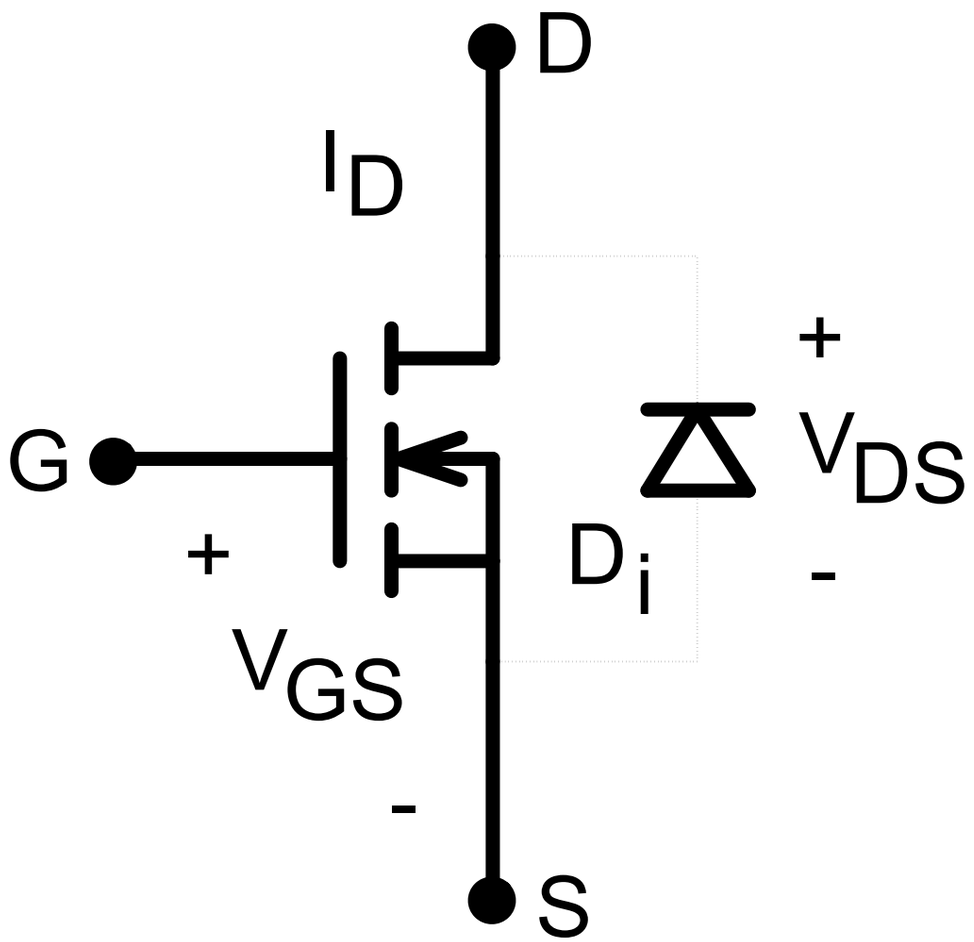


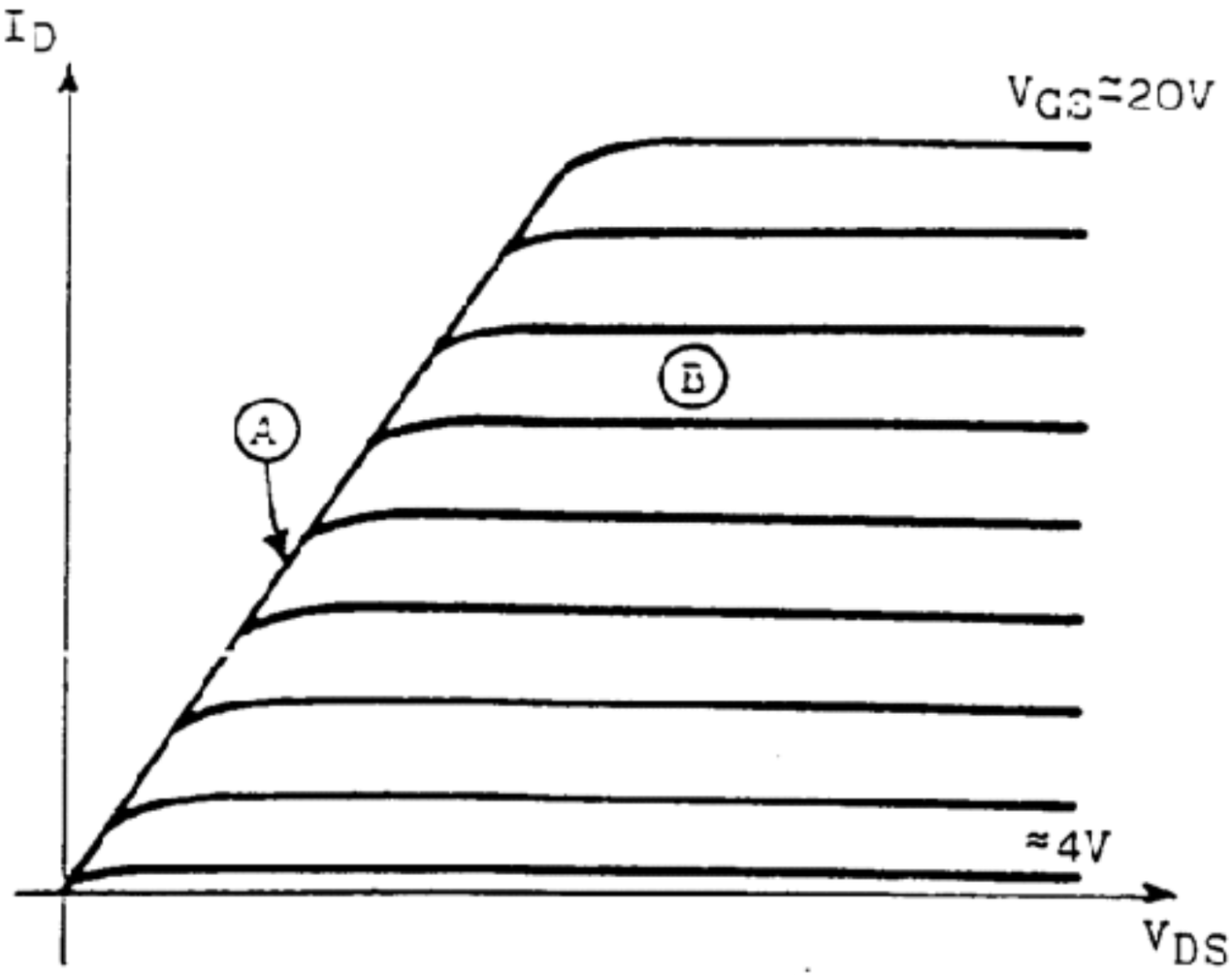


Canal n

MOSFET

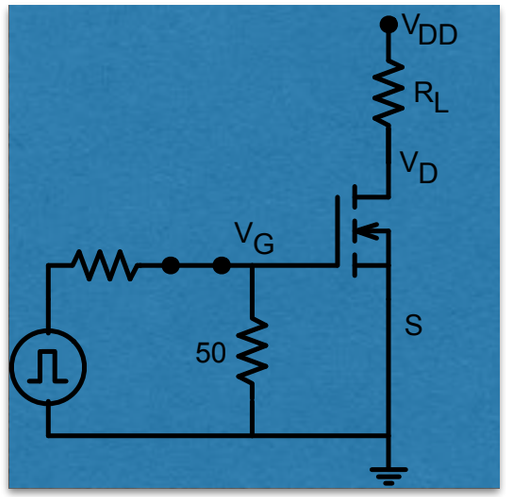
MOSFET de Potência

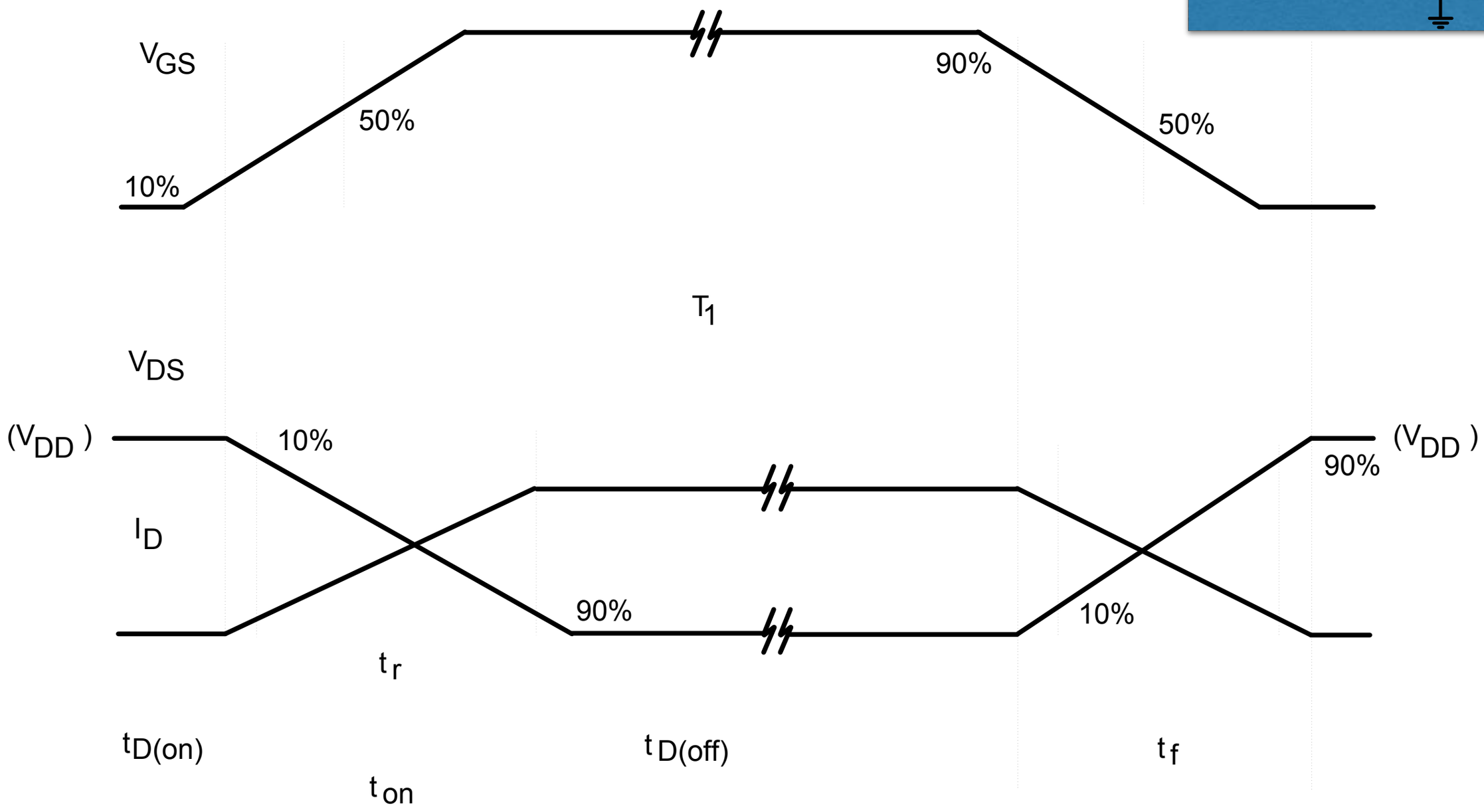




MOSFET

MOSFET de Potência

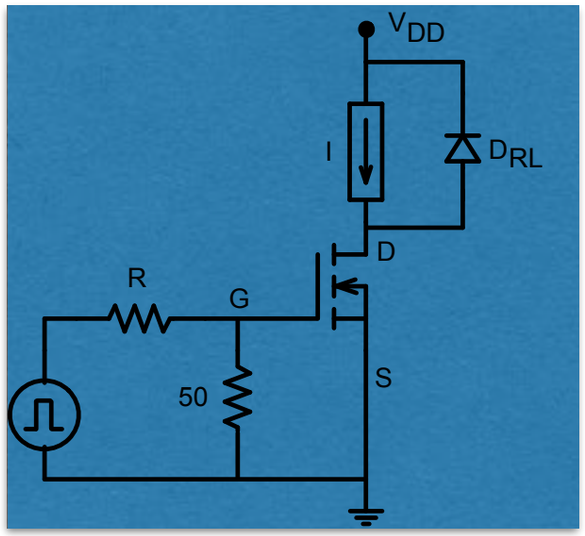


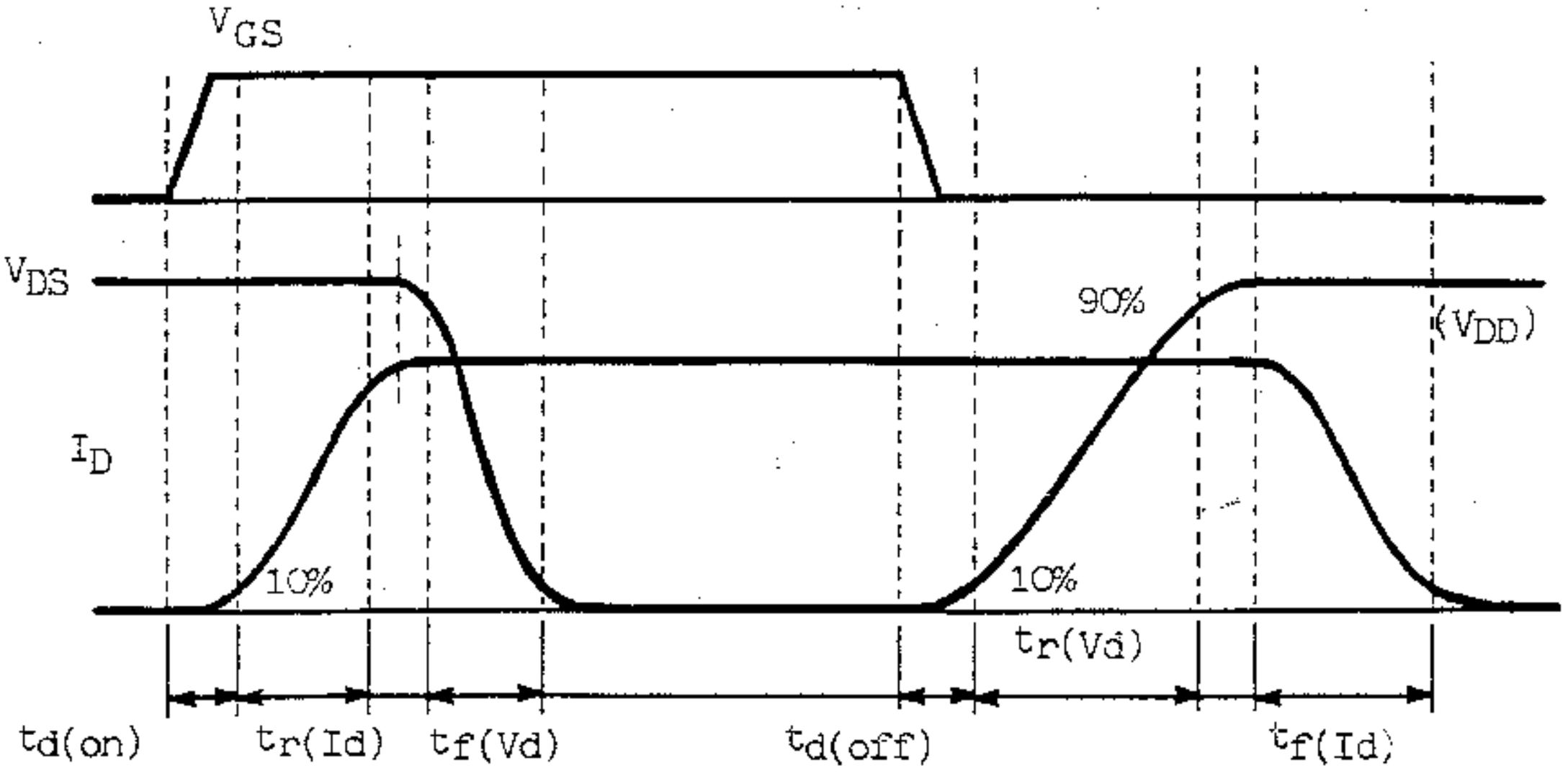


Comutação do MOSFET com carga resistiva

MOSFET

MOSFET de Potência





Comutação do MOSFET com carga indutiva

MOSFET

Classificação das perdas:

1. Condução;

$$P_{cond} = \frac{t_{on}}{T} \cdot r_{ds(on)} \cdot i_{d(on)}^{\ 2}$$

2. Comutação:
   - Entrada em condução e bloqueio;
   - Onde:

$$t_f \cong t_{on}$$

$$t_r \cong t_{off}$$

MOSFET

Dados de catalogo:

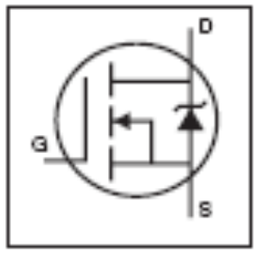
PD - 94459A

International
IOR Rectifier

IRFP150V

HEXFET® Power MOSFET

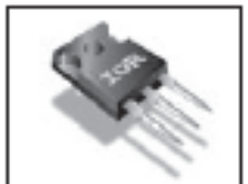
- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated



V_{DSS} = 100V

$R_{DS(on)}$ = 24mΩ

I_D = 47A



TO-247AC

Description

Advanced HEXFET® Power MOSFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole.

Absolute Maximum Ratings

	Parameter	Max.	Units
I_D @ T_C = 25°C	Continuous Drain Current, V_{GS} @ 10V	46	A
I_D @ T_C = 100°C	Continuous Drain Current, V_{GS} @ 10V	32	
I_{DM}	Pulsed Drain Current ①	230	
P_D @T_C = 25°C	Power Dissipation	140	W
	Linear Derating Factor	0.91	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
I_{AR}	Avalanche Current①	28	A
E_{AR}	Repetitive Avalanche Energy①	20	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.8	V/ns
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 175	°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torque, 6-32 or M3 srew	10 lbf•in (1.1 N•m)	

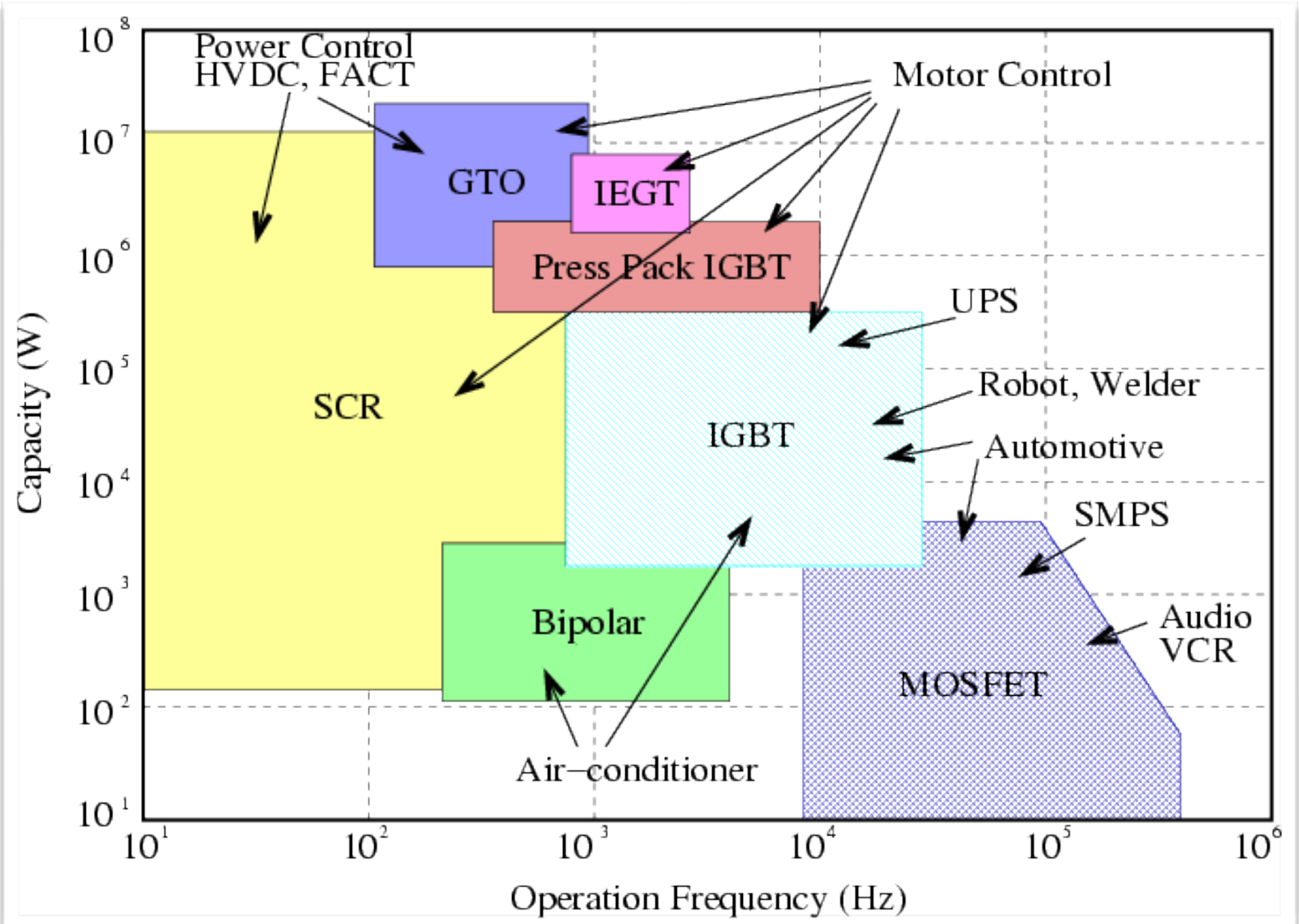
Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	1.1	°C/W
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient	—	40	

MOSFET

Quando usar MOSFET:

1. Freqüências altas (acima de 50 kHz);
2. Tensões muito baixas (< 500 V);
3. Potências baixas (< 1 kW).



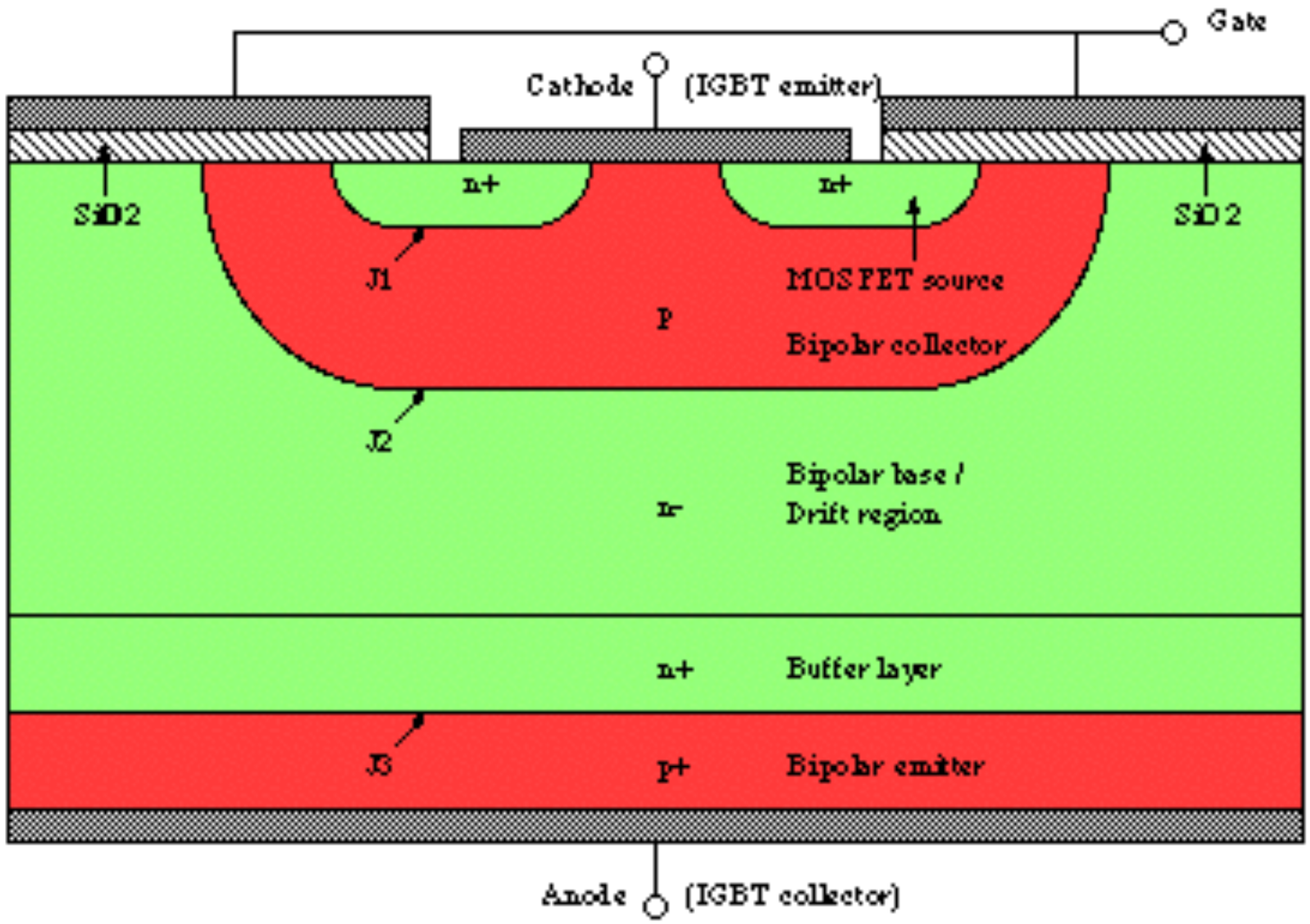
Demonstração

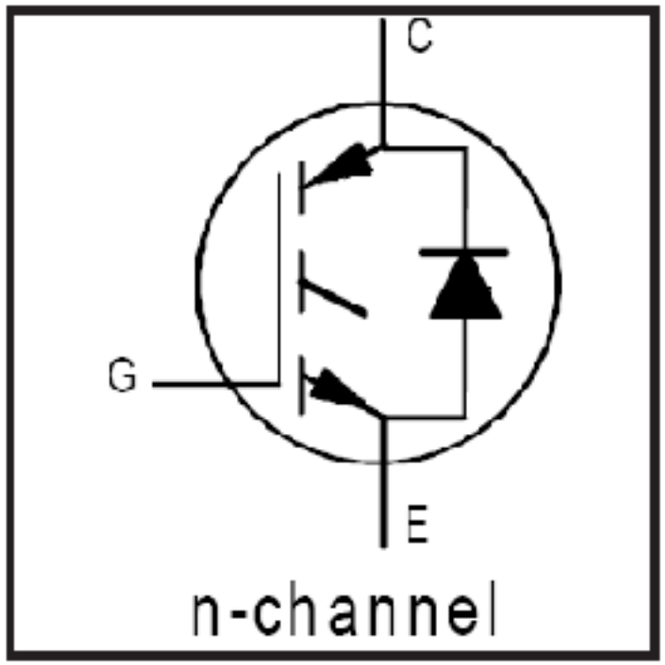
Demo

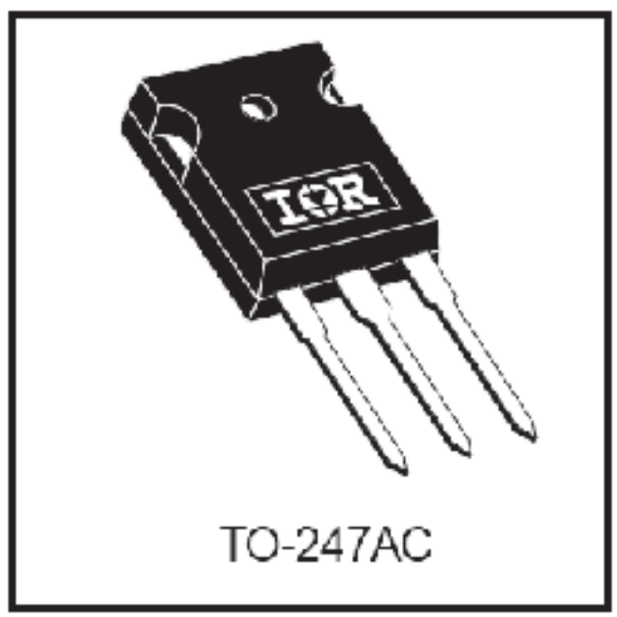
- Testes de MOSFET com multímetro.

IGBT

IGBT - Insulated Gate Bipolar Transistor







Características de BJT e MOSFET

IGBT

Classificação das perdas:

1. Condução;

$$P_{cond} = \left(i_C \cdot V_{CEsat} + i_B \cdot V_{BEsat} \right) \cdot t_{on} \cdot f$$

0

2. Comutação:
   - Entrada em condução e bloqueio;

   - Onde:

$$P_{com} = \frac{1}{2}\left(t_r + t_f \right) \cdot I \cdot E \cdot f$$

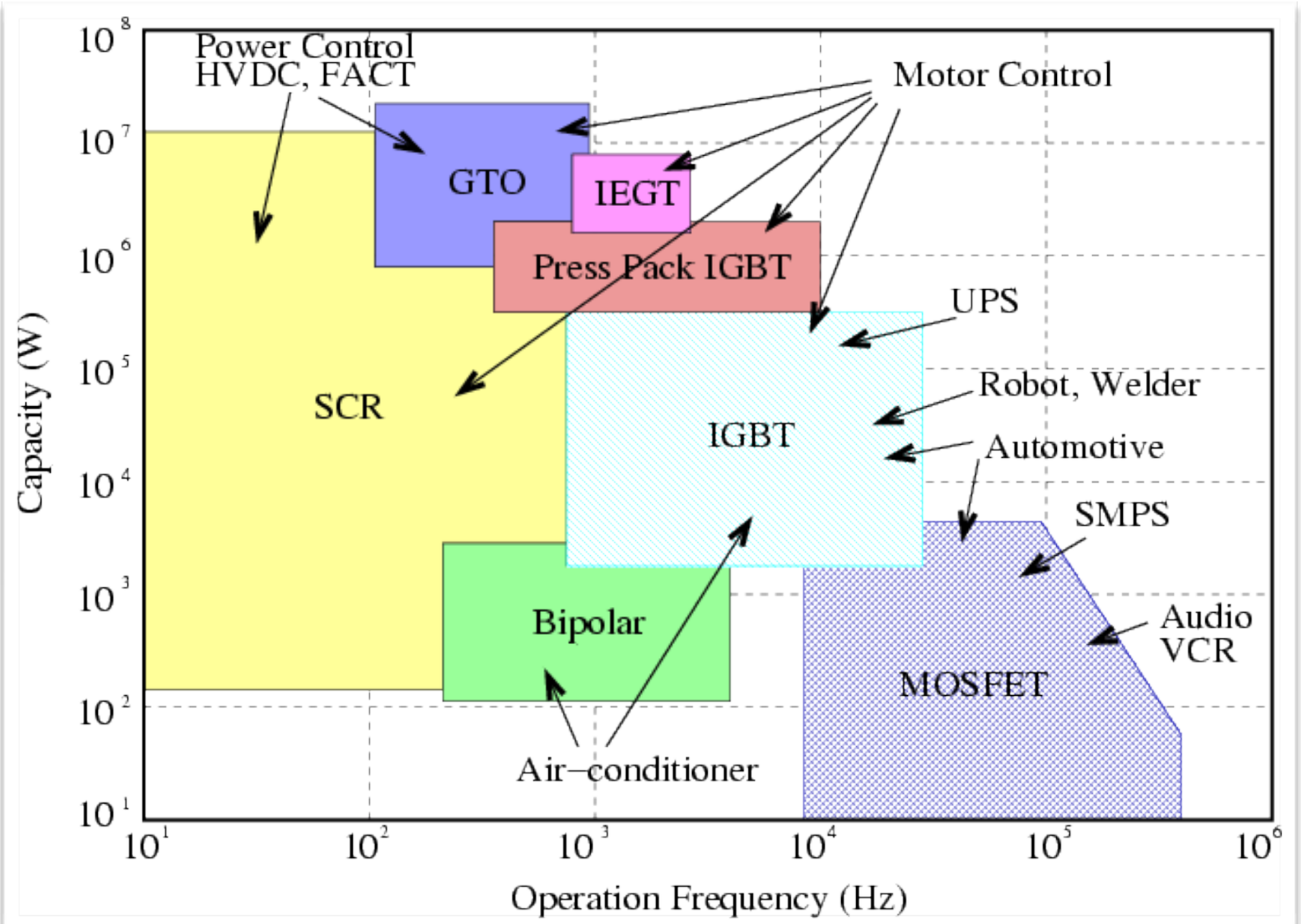
Detalhamento do cálculo de perdas

IGBT

Quando usar IGBT:

1. Freqüências baixas (menor que 50 kHz);
2. Tensões altas (> 500 V);
3. Potências altas (> 1 kW).

Part	Family	Package	Circuit	Switching Speed
[illegible]	IGBT Discretes	TO-247AC	Discrete	ULTRAFAST 4-20 kHz
[illegible]	IGBT Discretes	TO-247AC	Discrete	ULTRAFAST 8-60 kHz
[illegible]	IGBT Discretes	TO-247AC	Discrete	DC-1 KHz (STANDARD)
[illegible]	IGBT Discretes	TO-247AC	Discrete	ULTRAFAST 8-60 kHz
[illegible]	IGBT Discretes	TO-220AB	Discrete	WARP 60-170 kHz
[illegible]	IGBT Discretes	TO-220AB	Discrete	ULTRAFAST 10-30 kHz
[illegible]	IGBT Discretes	TO-220AB	Discrete	ULTRAFAST 10-30 kHz
[illegible]	IGBT Discretes	TO-Pak	Discrete	ULTRAFAST 10-30 kHz
[illegible]	IGBT Discretes	TO-Pak	Discrete	Low Vcesat
[illegible]	IGBT Discretes	TO-247AD	Discrete	Low Vcesat



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IGBT

Quando usar IGBT:

1. Freqüências baixas (menor que 50 kHz);
2. Tensões altas (> 500 V);
3. Potências altas (> 1 kW).

www.irf.com

Part	Family	Package	Circuit	Switching Speed	VCES (V)	VCE(ON) (V)	IC @ 25C (A)	IC @ 100C (A)	PD @25C (W)
IRG4PH30K	IGBT Discretes	TO-247AC	Discrete	ULTRAFAST 4-20 kHz	1200	4.20	20	10	100
IRG4PC20U	IGBT Discretes	TO-247AC	Discrete	ULTRAFAST 8-60 kHz	600	2.1	13	6.5	60
IRG4PC30S	IGBT Discretes	TO-247AC	Discrete	DC-1 kHz (STANDARD)	600	1.60	34	18	100
IRG4PC60U	IGBT Discretes	TO-247AC	Discrete	ULTRAFAST 8-60 kHz	600	2.00	75	40	520
IRG4BC30W	IGBT Discretes	TO-220AB	Discrete	WARP 60-150 kHz	600	2.70	23	12	100
IRGB30B60K	IGBT Discretes	TO-220AB	Discrete	ULTRAFAST 10-30 kHz	600	2.35	78	50	370
IRGB8B60K	IGBT Discretes	TO-220AB	Discrete	ULTRAFAST 10-30 kHz	600	2.2	17	9.0	140
IRGS6B60K	IGBT Discretes	D2-Pak	Discrete	ULTRAFAST 10-30 kHz	600	1.80	13	7	90
IRGS14C40L	IGBT Discretes	D2-Pak	Discrete	Low-Vceon	430	1.40	20	14	125
IRGP4050	IGBT Discretes	TO-247AC	Discrete	Low-Vceon	250	1.90	104	56	330

IGBT

Encapsulamentos:

www.semikron.com

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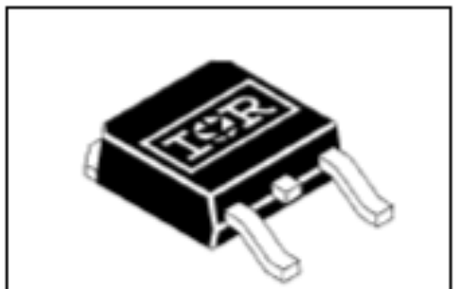
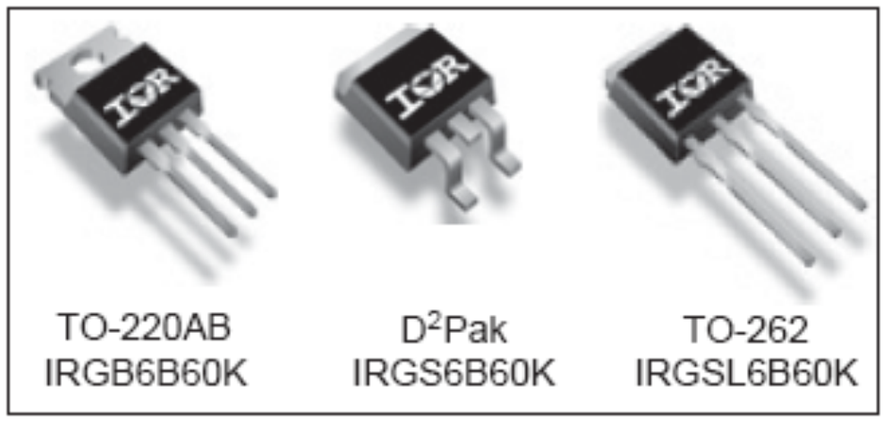
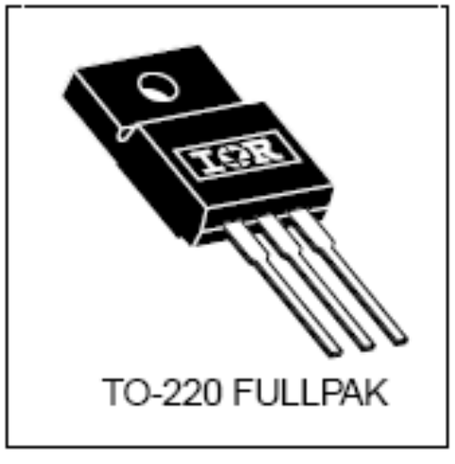
IGBT

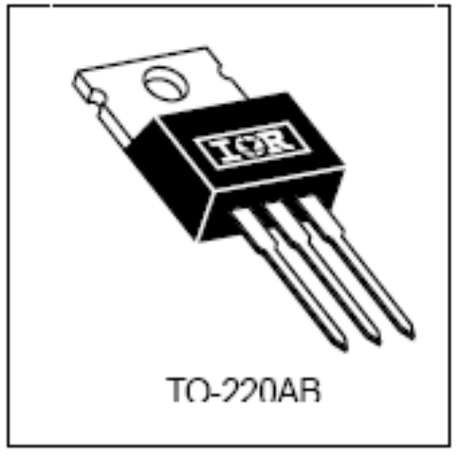
Encapsulamentos:

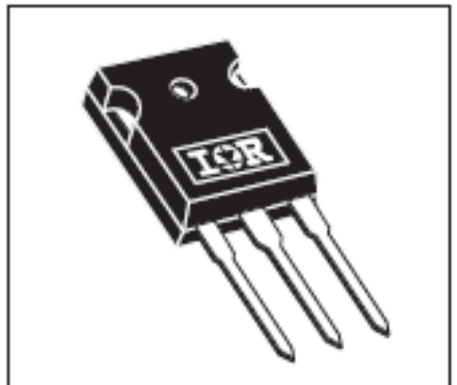


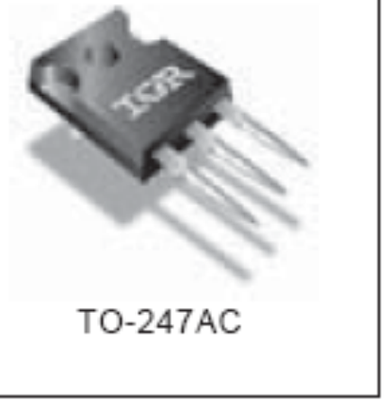


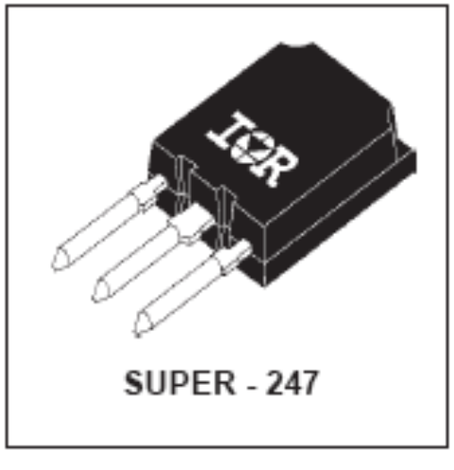
www.irf.com











BJT x MOSFET x IGBT

	MOSFET	IGBT	BJT
Tipo de comando	Tensão	Tensão	Corrente
Potência do comando	Mínima	Mínima	Grande
Complexidade do comando	Simples	Simples	Média
Densidade de corrente	Elevada em baixas tensões e Baixa em altas tensões	Muito elevada	Média
Perdas de comutação	Muito baixa	Baixa para Média	Média para Alta

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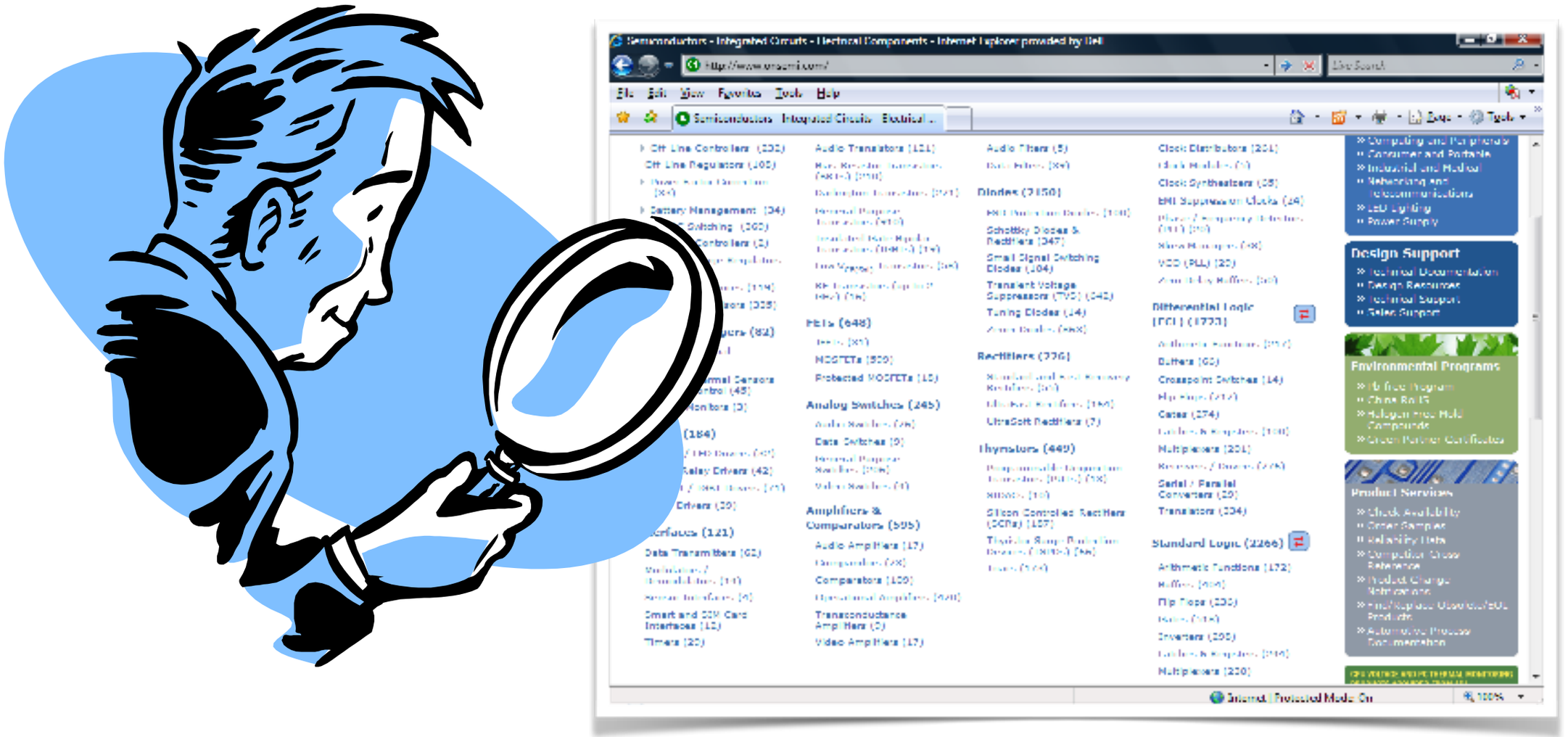
Próxima Aula

Componentes Semicondutores:

- Dimensionamento e especificação de semicondutores.



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